

DATASHEET

1.9mm Round Subminiature "Yoke"Lead Infrared LED EAISG2522A0



Features

- Small double-end package
- High reliability
- Low forward voltage
- Good spectral matching to Si photodetector
- Pb free
- The product itself will remain within RoHS compliant version.

Descriptions

EAISG2522A0 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens. The device is spectrally matched with silicon photodiode and phototransistor.

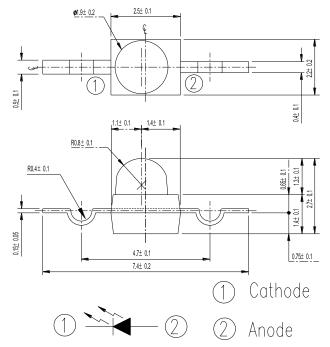
Applications

- PCB mounted infrared sensor
- Infrared emitting for miniature light barrier
- Floppy disk drive
- Optoelectronic switch
- Smoke detector

Device Selection Guide

Part Category	Chip Material	Lens Color	
EAISG2522A0	GaAlAs	Water Clear	

Package Dimensions



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Notes: 1.All dimensions are in millimeters

2.Tolerances unless dimensions ±0.1mm

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Units	
Continuous Forward Current	$I_{\rm F}$	65	mA	
Peak Forward Current	I _{FP}	1.0	А	
Reverse Voltage	V _R	5	V	
Operating Temperature	T _{opr}	-40 ~ +85	°C	
Storage Temperature	T _{stg}	-40 ~ +85	°C	
Soldering Temperature	T_{sol}	260	°C	
Power Dissipation at(or below)	P_d	130	mW	
25°C Free Air Temperature				

Notes: *1:I_{FP} Conditions--Pulse Width $\leq 100 \,\mu$ s and Duty $\leq 1\%$.

*2:Soldering time \leq 5 seconds.

Electro-Optical Characteristics (Ta=25°C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units
Radiant Intensity	Ee	I _F =20mA	3.0	5.0		mW /sr
		$I_F\!\!=\!\!100mA$ Pulse Width $\!\leq\!100\mus$,Duty $\!\leq\!1\%$		25		
Peak Wavelength	λp	I _F =20mA		940		nm
Spectral Bandwidth	Δλ	I _F =20mA		45		nm
Forward Voltage	V _F	I _F =20mA		1.2	1.5	V
		$I_F\!\!=\!\!100mA$ Pulse Width $\!\leq\!100\mus$,Duty $\!\leq\!1\%$		1.4	1.8	
		I _F =1A		2.6	4.0	
Reverse Current	I _R	V _R =5V			10	μA
View Angle	2 0 1/2	I _F =20mA		25		deg

Typical Electro-Optical Characteristics Curves

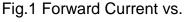
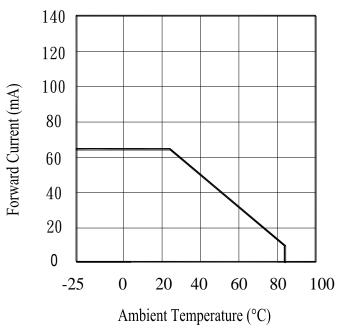
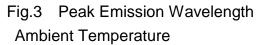
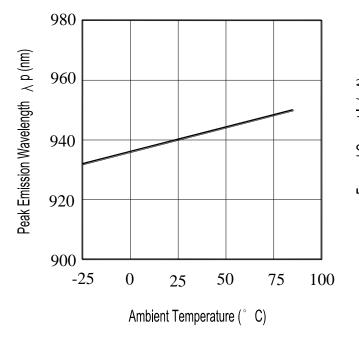


Fig.2 Spectral Distribution

Ambient Temperature







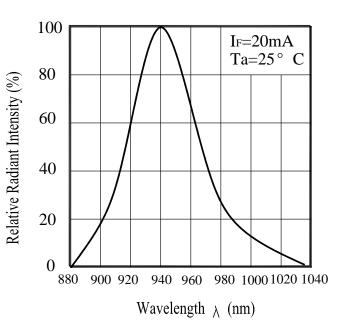
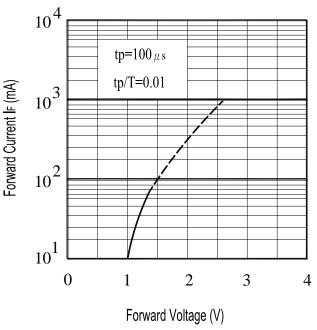


Fig.4 Forward Current vs. Forward Voltage



Typical Electro-Optical Characteristics Curves

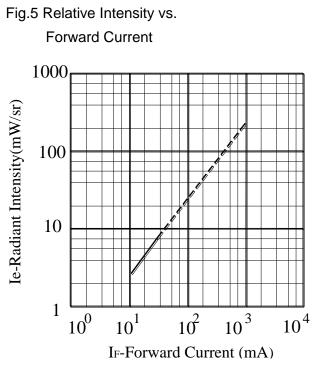


Fig.7 Relative Intensity vs. Ambient Temperature(°C)

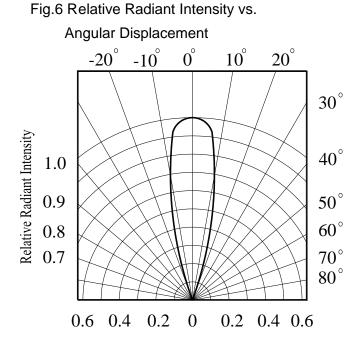
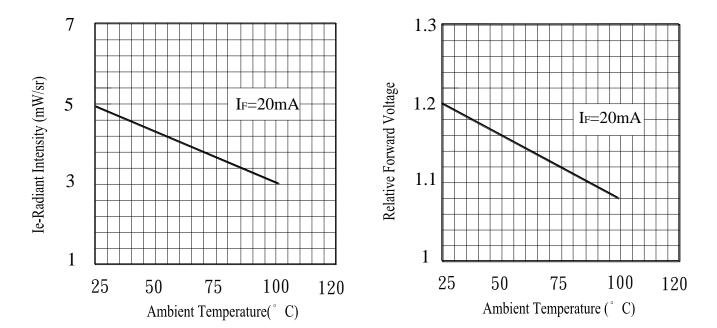


Fig.8 Forward Voltage vs. Ambient Temperature(°C)



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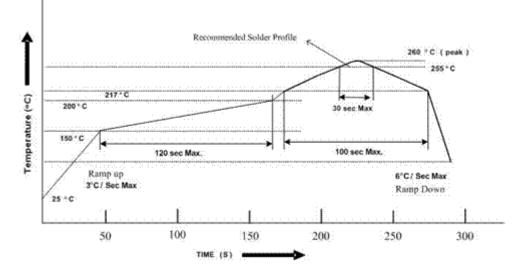
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

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- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package: The LEDs should be kept at 30° C or less and 90%RH or less.
 - 2.3 The LEDs should be used within a year.
 - 2.4 After opening the package, the LEDs should be kept at 30° C or less and 60%RH or less.
 - 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
 - 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions. Baking treatment : 60±5°C for 48 hours.
- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



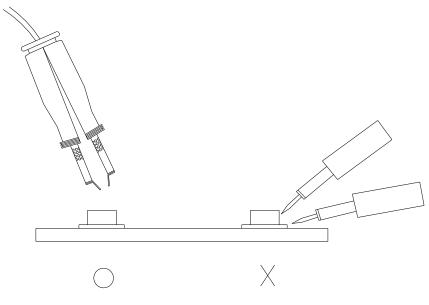
- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

4. Soldering Iron

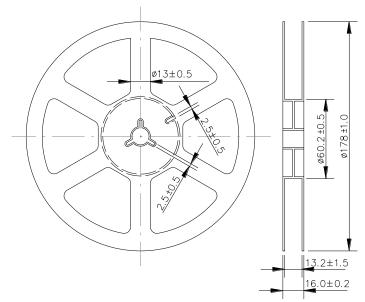
Each terminal is to go to the tip of soldering iron temperature less than 350° for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



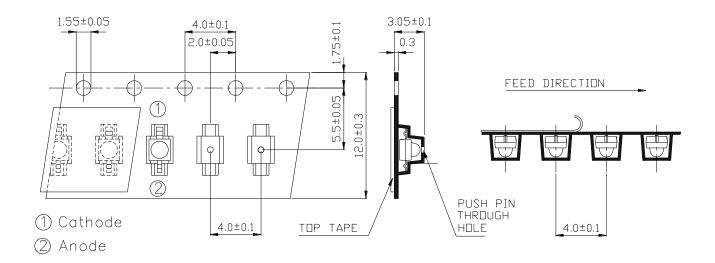
Package Dimensions



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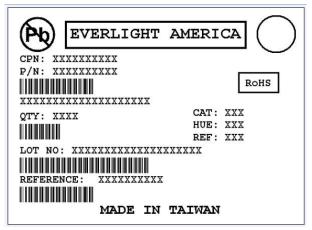
Loaded Quantity Per Reel 1000PCS/Reel



Unit : mm Packing Quantity Specification

- 1. 1000Pcs/1Volume , 1Volume/1Bag
- 2.10Boxes/1Carton

Label Form Specification



CPN: Customer's Production Number P/N : Production Number QTY: Packing Quantity CAT: Ranks HUE: Peak Wavelength REF: Reference LOT No: Lot Number

Notes

- 1. Above specification may be changed without notice. Everlight Americas will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. Everlight Americas assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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